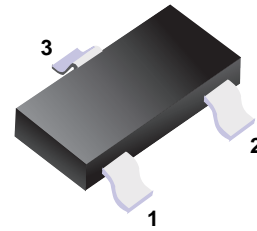


## N-Channel MOSFET

### ■ Features

- 0.22 A, 25 V.  $R_{DS(on)} = 4 \Omega @ V_{GS} = 4.5 V$   
 $R_{DS(on)} = 5 \Omega @ V_{GS} = 2.7 V.$
- Very low level gate drive requirements allowing direct operation in 3V circuits.  $V_{GS(th)} < 1.5V.$
- Gate-Source Zener for ESD ruggedness.  
 $>6kV$  Human Body Model
- Replace multiple NPN digital transistors with one DMOSFET.



1. Gate
2. Source
3. Drain

### ■ Simplified outline(SOT-23)

### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage, Power Supply Voltage	$V_{DSS}, V_{CC}$	25	V
Gate-Source Voltage, $V_{IN}$	$V_{GS}, V_I$	8	V
Drain/Output Current - Continuous	$I_D$	0.22	A
- pulse		0.5	A
Maximum Power Dissipation	$P_D$	0.35	W
Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)	ESD	6	kV
Thermal Resistance, Junction-to- Ambient	$R_{\theta JA}$	357	$^\circ C/W$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ C$

### ■ Inverter Electrical Characteristics $T_A = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Zero Input Voltage Output Current	$I_{O(off)}$	$V_{CC} = 20 V, V_I = 0 V$			1.0	$\mu A$
Input Voltage	$V_{I(off)}$	$V_{CC} = 5 V, I_O = 10 \mu A$			0.5	V
	$V_{I(on)}$	$V_O = 0.3 V, I_O = 5 mA$	1.0			V
Output to Ground Resistance	$R_{O(on)}$	$V_I = 2.7 V, I_O = 0.2 A$			5.0	$\Omega$

**■ Electrical Characteristics Ta = 25°C unless otherwise noted**

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	25			V
Breakdown Voltage Temp. Coefficient	ΔV <sub>DSS</sub> /ΔT <sub>J</sub>	I <sub>D</sub> = 250 μA, Referenced to 25°C		25		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μA
		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55°C			10	μA
Gate-Body Leakage Current, Forward	I <sub>GSSF</sub>	V <sub>GS</sub> = 8 V, V <sub>DS</sub> = 0 V			100	nA
Gate-Body Leakage Current, Reverse	I <sub>GSSR</sub>	V <sub>GS</sub> = -8 V, V <sub>DS</sub> = 0 V			-100	nA
Gate Threshold Voltage (Note)	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.65	0.8	1.5	V
Gate Threshold Voltage Temp. Coefficient (Note)	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA, Referenced to 25°C		-2.1		mV/°C
Static Drain-Source On-Resistance(Note)	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.4A			4.0	Ω
		V <sub>GS</sub> = 2.7V, I <sub>D</sub> = 0.2 A			5.0	
On-State Drain Current (Note)	I <sub>D(on)</sub>	V <sub>GS</sub> = 2.7 V, V <sub>DS</sub> = 5 V	0.2			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 0.4 A		0.2		S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		9.5		pF
Output Capacitance	C <sub>oss</sub>			6.0		
Reverse Transfer Capacitance	C <sub>rss</sub>			1.3		
Turn-On Delay Time (Note)	t <sub>d(on)</sub>	V <sub>DD</sub> = 6V, I <sub>D</sub> = 0.5A, V <sub>GS</sub> = 4.5V, R <sub>GEN</sub> = 50Ω		3.2	8	ns
Turn-On Rise Time (Note)	t <sub>r</sub>			6	15	
Turn-Off Delay Time (Note)	t <sub>d(off)</sub>			3.5	8	
Turn-Off Fall Time (Note)	t <sub>f</sub>			3.5	8	
Total Gate Charge (Note)	Q <sub>g</sub>				0.49	
Gate-Source Charge (Note)	Q <sub>gs</sub>	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 0.2A, V <sub>GS</sub> = 4.5V,		0.22		nC
Gate-Drain Charge (Note)	Q <sub>gd</sub>			0.07		
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>				0.29	A
Drain-Source Diode Forward Voltage(Note)	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 0.29 A			1.2	V

Note: Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%.

## ■ Typical Characteristics

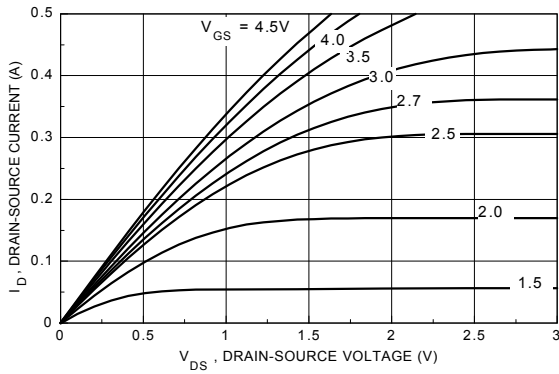


Figure 1. On-Region Characteristics.

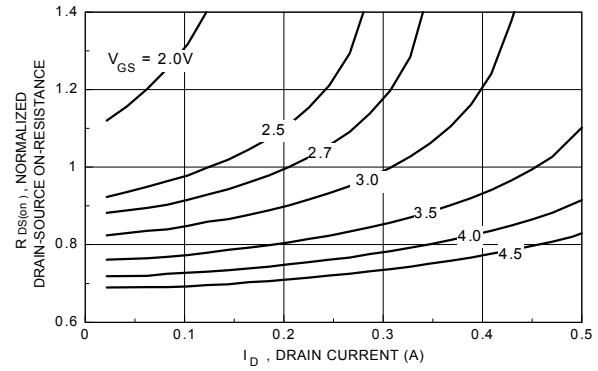


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

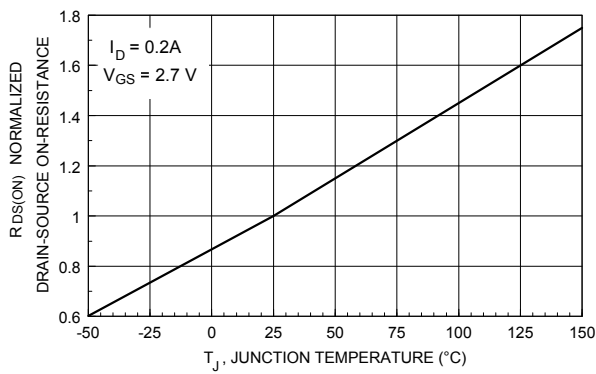


Figure 3. On-Resistance Variation with Temperature.

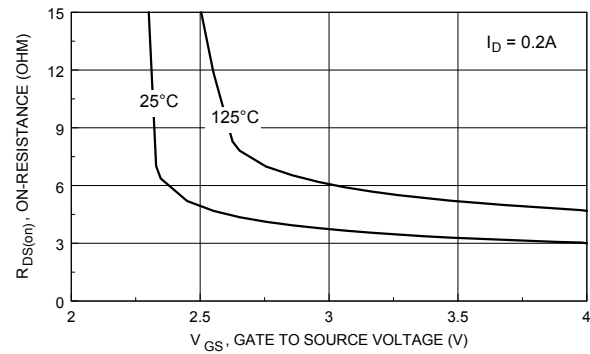


Figure 4. On-Resistance Variation with Gate-To-Source Voltage.

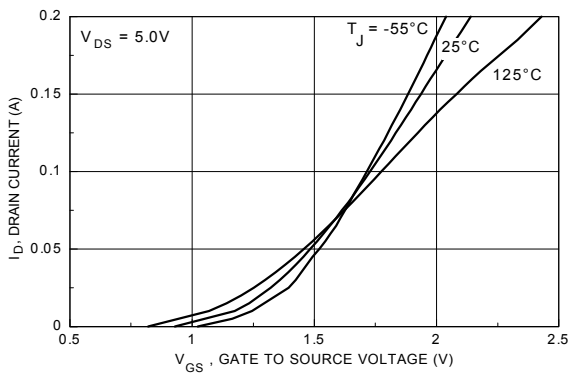


Figure 5. Transfer Characteristics.

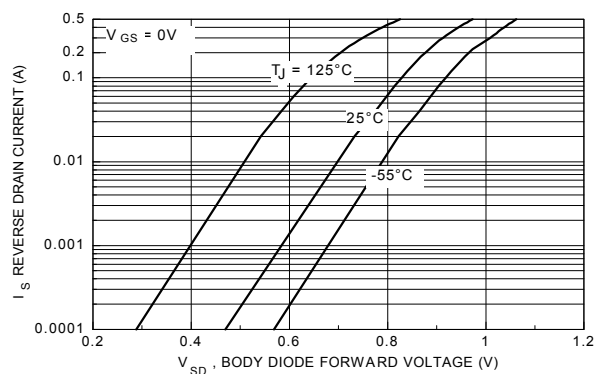
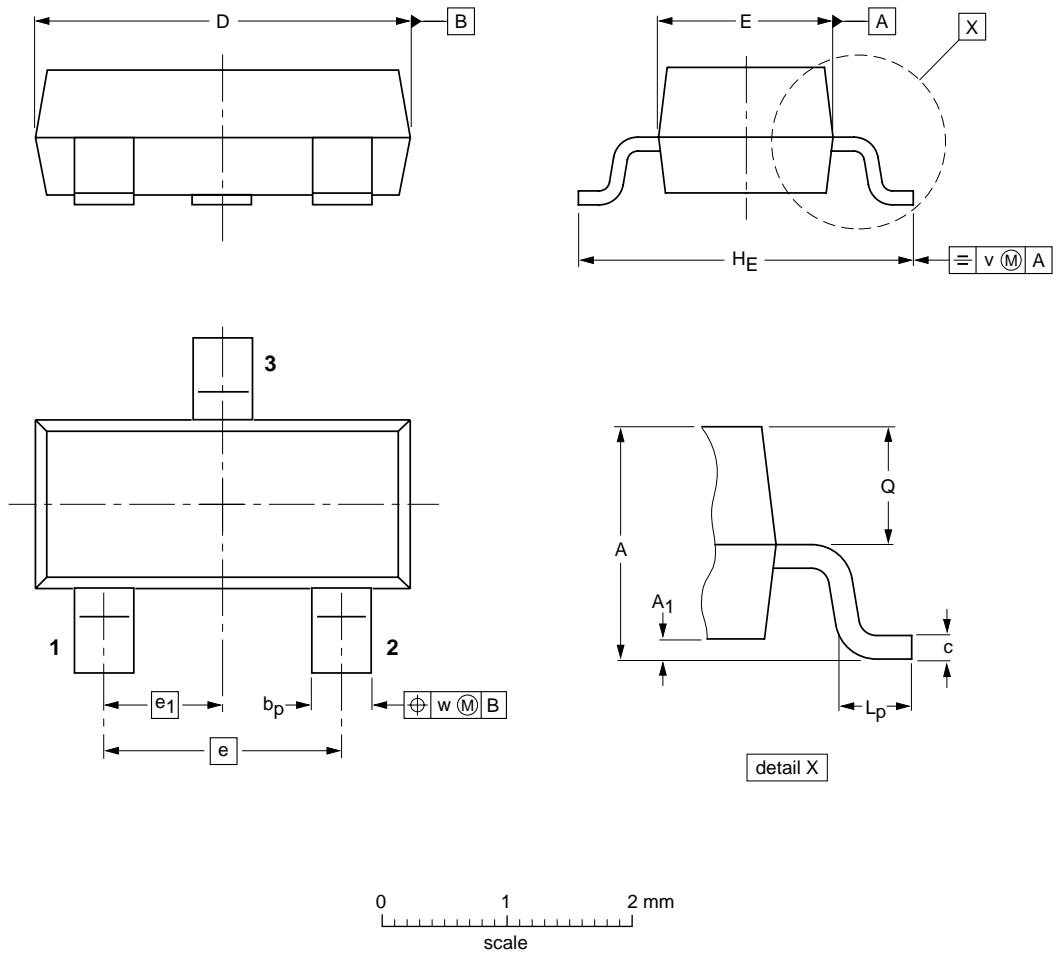


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.



## ■ SOT-23



**DIMENSIONS (mm are the original dimensions)**

UNIT	A	A <sub>1</sub> max.	b <sub>p</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1